

NPN SILICON EPITAXIAL TRANSISTOR FOR HIGH-SPEED SWITCHING

The 2SC4814 is a power transistor featuring low-saturation voltage and high hre. This transistor is ideal for highprecision control such as PWM control for pulse motors or brushless motors in OA and FA equipment and for solenoid driving in automotive equipment.

In addition, this transistor features a package that can be auto-mounted in radial taping specifications, thus contributing to mounting cost reduction.

FEATURES

NEC

- Low VCE(sat): VCE(sat) ≤ 0.3 V @Ic = 1.5 A, IB = 10 mA
- High hFE: hFE = 300 to 1,200 @VCE = 2.0 V, IC = 1.0 A
- On-chip dumper-diode
- · Auto-mounting possible in radial taping specifications

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Conditions	Ratings	Unit
Collector to base voltage	Vсво		120	V
Collector to emitter voltage	VCEO		100	V
Emitter to base voltage	VEBO		7.0	V
Collector current (DC)	IC(DC)		±2.5	А
Collector current (pulse)	IC(pulse)	PW \leq 300 μ s, duty cycle \leq 10%	±5.0	А
Base current (DC)	B(DC)		1.0	А
Total power dissipation	Рт	Ta = 25°C	1.8	W
Junction temperature	Tj		150	°C
Storage temperature	Tstg		–55 to +150	°C

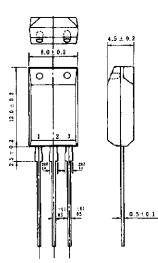
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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

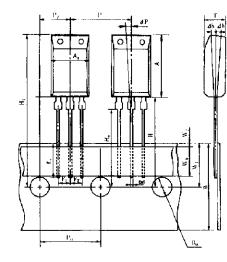
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 120 V, IE = 0			50	μA
Emitter cutoff current	Іево	V _{EB} = 5 V, Ic = 0			50	μA
DC current gain	hfe1*	Vce = 2 V, Ic = 1.0 A	300	700	1,200	-
DC current gain	hFE2*	Vce = 2 V, Ic = 1.5 A	250	600		-
Collector saturation voltage	V _{CE(sat)} *	Ic = 1.5 A, Iв = 10 mA			0.3	V
Base saturation voltage	V _{BE(sat)} *	Ic = 1.5 A, Iв = 10 mA			1.3	V
Gain bandwidth product	f⊤	Vce = 10 V, Ic = 1.0 A		60		MHz
Collector capacitance	Cob	$V_{CE} = 10 \text{ V}, \text{ I}_{E} = 0 \text{ , } f = 1 \text{ MHz}$		40		pF
Turn-on time	ton	Ic = 1.5 A, Iв1 = -Iв2 = 10 mA		0.5		μs
Storage time	tstg	$R_L = 8.0 \Omega$, $V_{CC} = 12 V$ Refer to the test circuit.		2.0		μs
Fall time	tr			0.5		μs

* Pulse test PW \leq 350 μ s, duty cycle \leq 2%

PACKAGE DRAWING (UNIT: mm)



TAPING SPECIFICATION



A,	8.0±0,2
A	13.0 ± 0.2
Do	\$4.0±0.2
d	0.5±0.1·
\mathbf{F}_1	$2.5^{+0.4}_{-0.1}$
\mathbf{F}_2	2.5-0.1
Н	20.0 MAX.
Ho	16.0±0.5
H,	32,2 MAX.
⊿h	0±1.0
l.	2.5 MIN,
P	12.7±1.0
Pe	12.7±0.3
Pz	6.35±0.5
⊿P	0±1.3
Т	4.5±0.2
W	18.0 ^{+1.0}
Wo	5.0 MIN.
Wt	9.0 ± 0.5
W ₂	0.7 MAX.

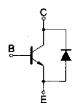
Electrode Connection

1. Base

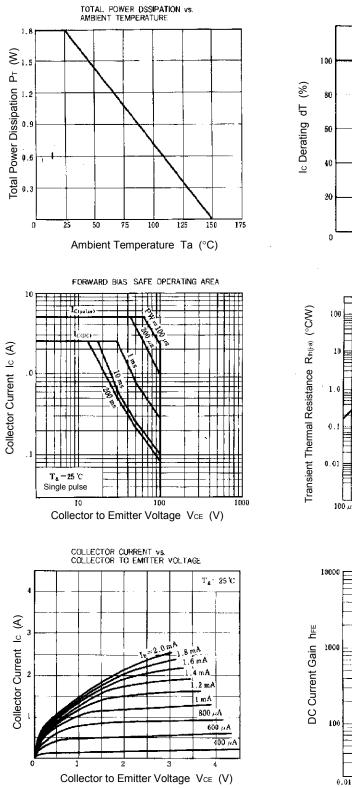
2. Collector

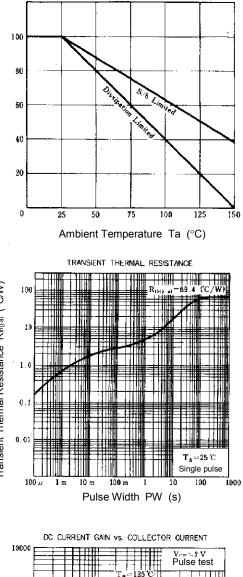
3. Emitter

EQUIVALENT CIRCUIT

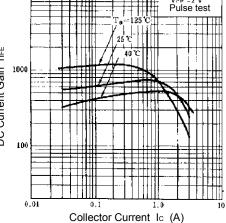


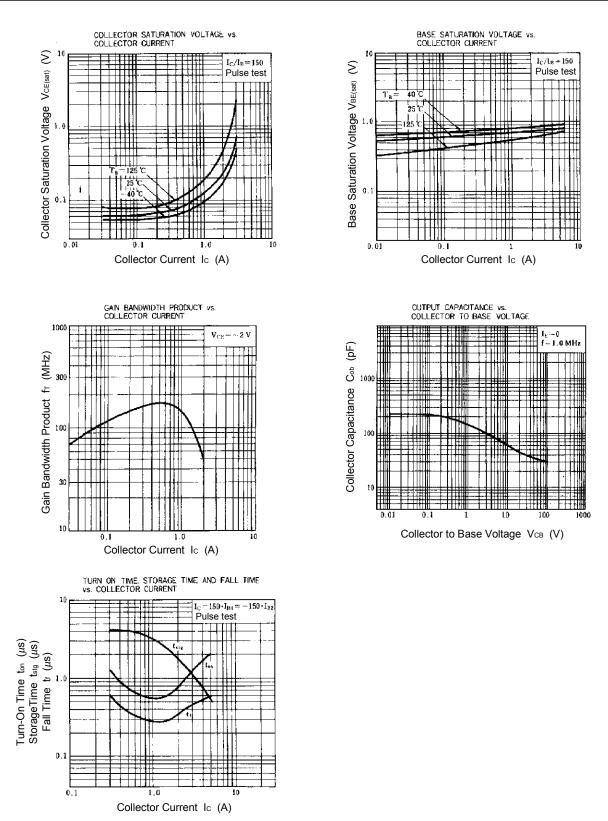
TYPICAL CHARACTERISTICS (Ta = 25°C)



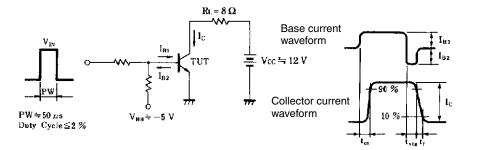


DERATING CURVE OF SAFE OPERATING AREA





SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT



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